

PS9506,PS9506L1, PS9506L2,PS9506L3

Data Sheet R08DS0018EJ0100 Rev.1.00 Nov 10, 2011

0.6 A OUTPUT CURRENT, HIGH CMR, IGBT GATE DRIVE, 8-PIN DIP PHOTOCOUPLER

DESCRIPTION

The PS9506, PS9506L1, PS9506L2 and PS9506L3 are optically coupled isolators containing a GaAlAs LED on the input side and a photo diode, a signal processing circuit and a power output transistor on the output side on one chip. The PS9506 Series is designed specifically for high common mode transient immunity (CMR) and high switching speed.

The PS9506 Series is suitable for driving IGBTs and MOS FETs.

The PS9506 Series is in a plastic DIP (Dual In-line Package).

The PS9506L1 is lead bending type for long creepage distance.

The PS9506L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.

The PS9506L3 is lead bending type (Gull-wing) for surface mounting.

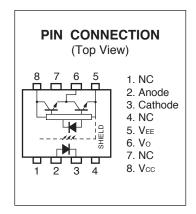
FEATURES

- Long creepage distance (8 mm MIN.: PS9506L1, PS9506L2)
- Peak output current (0.6 A MAX., 0.4 A MIN.)
- High speed switching (t_{PLH} , $t_{PHL} = 0.4 \ \mu s$ MAX.)
- High common mode transient immunity (CM_H, CM_L = $\pm 25 \text{ kV}/\mu \text{s}$ MIN.)
- Embossed tape product : PS9506L2-E3, PS9506L3-E3: 1 000 pcs/reel

- Pb-Free product Safety standards
 - UL approved: No. E72422
 - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
 - SEMKO approved: No. 1115598
 - DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40024069 (Option)

APPLICATIONS

- IGBT, Power MOS FET Gate Driver
- Industrial inverter
- IH (Induction Heating)



The mark <R> shows major revised points.

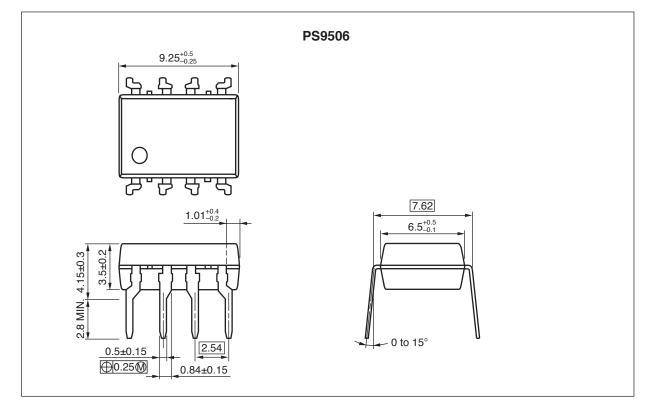
The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.



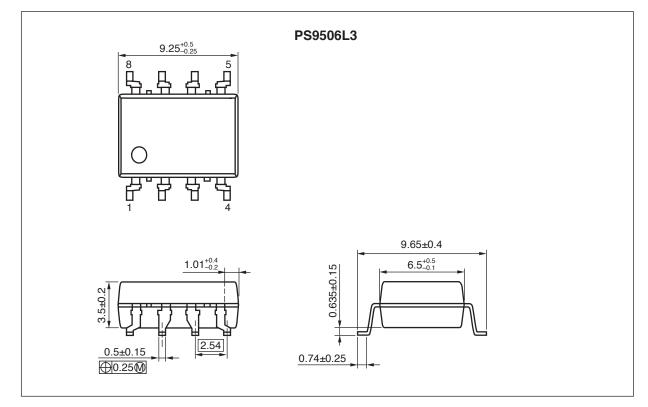


PACKAGE DIMENSIONS (UNIT: mm)

DIP Type



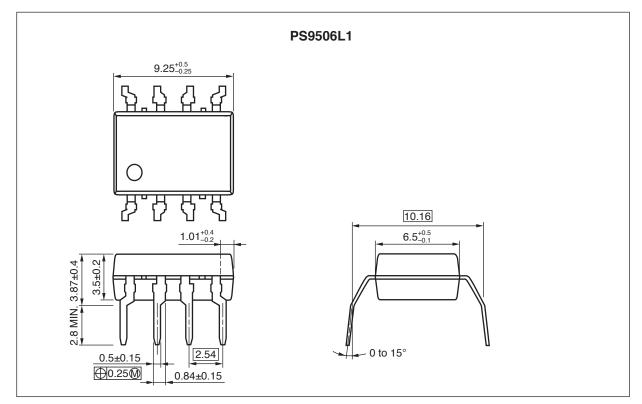
Lead Bending Type (Gull-wing) For Surface Mount



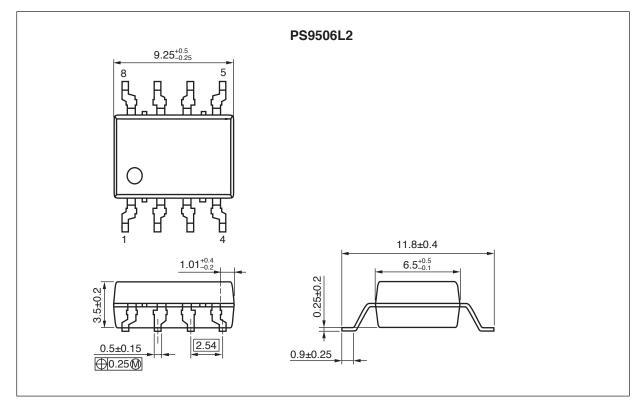


A Business Partner of Renesas Electronics Corporation. CEL California Eastern Laboratories

Lead Bending Type For Long Creepage Distance



Lead Bending Type (Gull-wing) For Long Creepage Distance (Surface Mount)



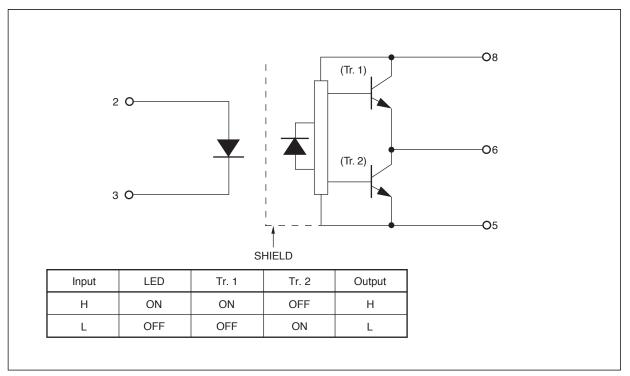




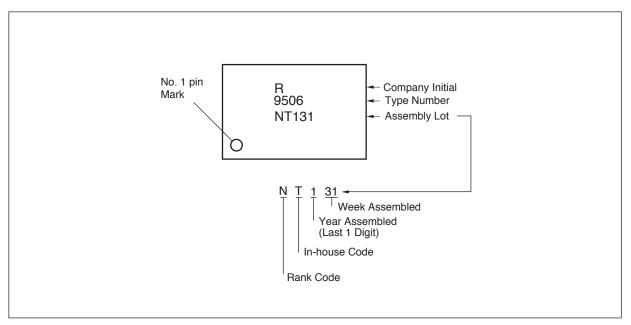
PHOTOCOUPLER CONSTRUCTION

Parameter	PS9506 ,PS9506L3	PS9506L1, PS9506L2
Air Distance (MIN.)	7 mm	8 mm
Outer Creepage Distance (MIN.)	7 mm	8 mm
Isolation Distance (MIN.)	0.4 mm	0.4 mm

FUNCTIONAL DIAGRAM



<R> MARKING EXAMPLE







<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS9506	PS9506-AX	Pb-Free	50 Magazine Cases	Standard	PS9506
PS9506L1	PS9506L1-AX	(Ni/Pd/Au)		products	PS9506L1
PS9506L2	PS9506L2-AX			(UL, CSA, SEMKO	PS9506L2
PS9506L3	PS9506L3-AX			approved)	PS9506L3
PS9506L2-E3	PS9506L2-E3-AX		Embossed Tape		PS9506L2
PS9506L3-E3	PS9506L3-E3-AX		1 000 pcs/reel		PS9506L3
PS9506-V	PS9506-V-AX		50 Magazine Cases	DIN EN60747-5-2	PS9506
PS9506L1-V	PS9506L1-V-AX			(VDE0884 Part2)	PS9506L1
PS9506L2-V	PS9506L2-V-AX			approved	PS9506L2
PS9506L3-V	PS9506L3-V-AX			(Option)	PS9506L3
PS9506L2-V-E3	PS9506L2-V-E3-AX		Embossed Tape		PS9506L2
PS9506L3-V-E3	PS9506L3-V-E3-AX		1 000 pcs/reel		PS9506L3

Note: *1. For the application of the Safety Standard, following part number should be used.



A Business Partner of Renesas Electronics Corporation. CEL California Eastern Laboratories

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current	IF	25	mA
	Peak Transient	I _{F (TRAN)}	1.0	A
	Forward Current			
	(Pulse Width < 1 μ s)			
	Reverse Voltage	V _R	5	V
	Power Dissipation *1	PD	45	mW
Detector	High Level Peak	I _{OH (PEAK)}	0.6	A
	Output Current *2			
	Low Level Peak	IOL (PEAK)	0.6	A
	Output Current *2			
	Supply Voltage	$(V_{CC}-V_{EE})$	0 to 35	V
	Output Voltage	Vo	0 to V _{CC}	V
	Power Dissipation *3	Pc	250	mW
Isolation \	Isolation Voltage *4		5 000	Vr.m.s.
Operating Frequency*5		f	50	kHz
Operating Ambient Temperature		T _A	-40 to +110	°C
Storage T	emperature	T _{stg}	–55 to +125	°C

Notes: *1. Reduced to 1.2 mW/°C at $T_A = 85^{\circ}C$ or more.

*2. Maximum pulse width = 10 μ s, Maximum duty cycle = 0.2%

*3. Reduced to 5.5 mW/°C at T_A = 75°C or more.

*4. AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-4 shorted together, 5-8 shorted together.

*5. $I_{OH (PEAK)} \le 0.4 \text{ A} (\le 2.0 \ \mu\text{s}), I_{OL (PEAK)} \le 0.4 \text{ A} (\le 2.0 \ \mu\text{s})$

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	$(V_{CC}-V_{EE})$	10		30	V
Forward Current (ON)	I _{F (ON)}	8		12	mA
Forward Voltage (OFF)	V _{F (OFF)}	-2		0.8	V
Operating Ambient Temperature	T _A	-40		110	°C



ELECTRICAL CHARACTERISTICS ($T_A = -40$ to +110°C, $V_{CC} = 10$ to 30 V, $I_{F (ON)} = 8$ to 12 mA, $V_{F (OFF)} = -2$ to 0.8 V, $V_{EE} = GND$, unless otherwise specified)

	Parameter		Conditions	MIN.	TYP. ^{*1}	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 10 mA, T _A = 25°C	1.2	1.56	1.8	V
	Reverse Current	I _R	V _R = 3 V, T _A = 25°C			10	μA
	Input Capacitance	C _{IN}	$f = 1 \text{ MHz}, V_F = 0 \text{ V}, T_A = 25^{\circ}\text{C}$		30		pF
Detector	High Level Output Current	I _{OH}	$V_{\rm O} = (V_{\rm CC} - 4 \ {\rm V})^{*2}$	0.2			А
			$V_{\rm O} = (V_{\rm CC} - 10 \text{ V})^{*3}$	0.4	0.5		
	Low Level Output Current	I _{OL}	$V_{O} = (V_{EE} + 2.5 V)^{*2}$	0.2	0.4		А
			$V_{O} = (V_{EE} + 10 \text{ V})^{*3}$	0.4	0.5		
	High Level Output Voltage	V _{OH}	$I_0 = -100 \text{ mA}^{*4}$	V _{CC} – 4.0	V _{CC} – 1.8		V
	Low Level Output Voltage	V _{OL}	I _O = 100 mA		0.4	1.0	V
	High Level Supply Current	I _{CCH}	I _F = 10 mA, I _O = 0 mA		0.7	3.0	mA
	Low Level Supply Current	I _{CCL}	$I_{F} = 0 \text{ mA}, I_{O} = 0 \text{ mA}$		1.2	3.0	mA
Coupled	Threshold Input Current	I _{FLH}	I _O = 0 mA, V _O > 5 V			7.0	mA
	$(L \rightarrow H)$						
	Threshold Input Voltage	V _{FHL}	I ₀ = 0 mA, V ₀ < 5 V	0.8			V
	$(H \rightarrow L)$						
	Isolation Capacitance	C _{I-O}	V _F = 0 V, f = 1 MHz, T _A = 25°C		0.7		pF

<R> <R>

Notes: *1. Typical values at TA = 25°C, $V_{CC} - V_{EE}$ = 30 V.

*2. Maximum pulse width = 50 μ s, Maximum duty cycle = 0.5%.

*3. Maximum pulse width = 10 μ s, Maximum duty cycle = 0.2%.

*4. V_{OH} is measured with the DC load current in this testing.





SWITCHING CHARACTERISTICS ($T_A = -40$ to +110°C, $V_{CC} = 10$ to 30 V, $I_{F(ON)} = 8$ to 12 mA, $V_{F(OFF)} = -2$ to 0.8 V, $V_{EE} = GND$, unless otherwise specified)

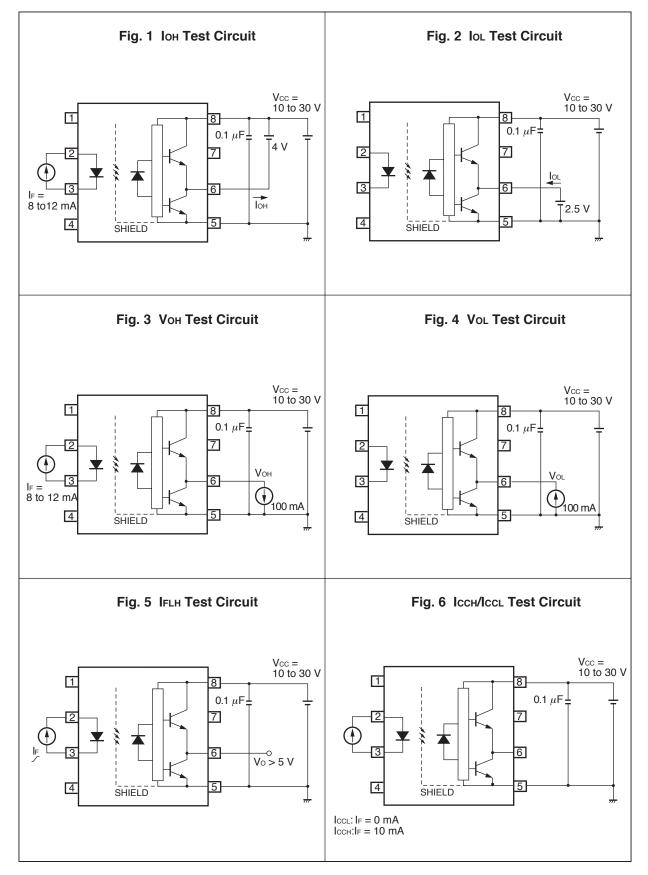
Parameter	Symbol	Conditions	MIN.	TYP. ^{*1}	MAX.	Unit
Propagation Delay Time (L \rightarrow H)	t _{PLH}	$R_{g} = 47 \Omega, C_{g} = 3 nF,$	0.05	0.18	0.4	μs
Propagation Delay Time ($H \rightarrow L$)	t _{PHL}	f = 10 kHz,	0.05	0.18	0.4	μs
Pulse Width Distortion (PWD)	t _{PHL} -t _{PLH}	Duty Cycle = 50% ^{*2} ,			0.25	μs
Propagation Delay Time (Difference Between Any Two Products)	t _{PHL} —t _{PLH}	I _F = 10 mA, V _{CC} = 30 V	-0.3		0.3	μs
Rise Time	tr			50		ns
Fall Time	t _f			50		ns
Common Mode Transient Immunity at High Level Output	CM _H	$ T_{A} = 25^{\circ}C, I_{F} = 10 \text{ mA}, \\ V_{CC} = 30 \text{ V}, V_{CM} = 1.5 \text{ kV}, \\ V_{O (MIN.)} = 26 \text{ V} $	25			kV/ <i>µ</i> s
Common Mode Transient Immunity at Low Level Output	CM∟	$ T_{A} = 25^{\circ}C, I_{F} = 0 \text{ mA}, \\ V_{CC} = 30 \text{ V}, V_{CM} = 1.5 \text{ kV}, \\ V_{O (MAX.)} = 1 \text{ V} $	25			kV/µs

Notes: *1. Typical values at $T_A = 25^{\circ}C$, $V_{CC} - V_{EE} = 30 V$.

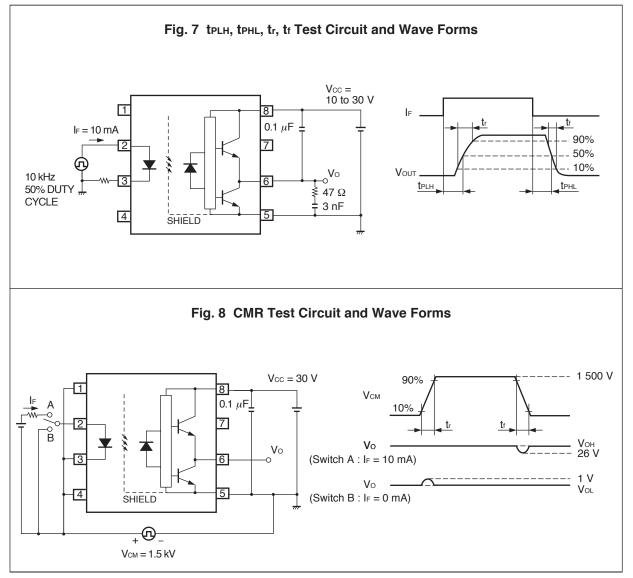
*2. This load condition is equivalent to the IGBT load at 1 200 V/25 A.



<R> TEST CIRCUIT





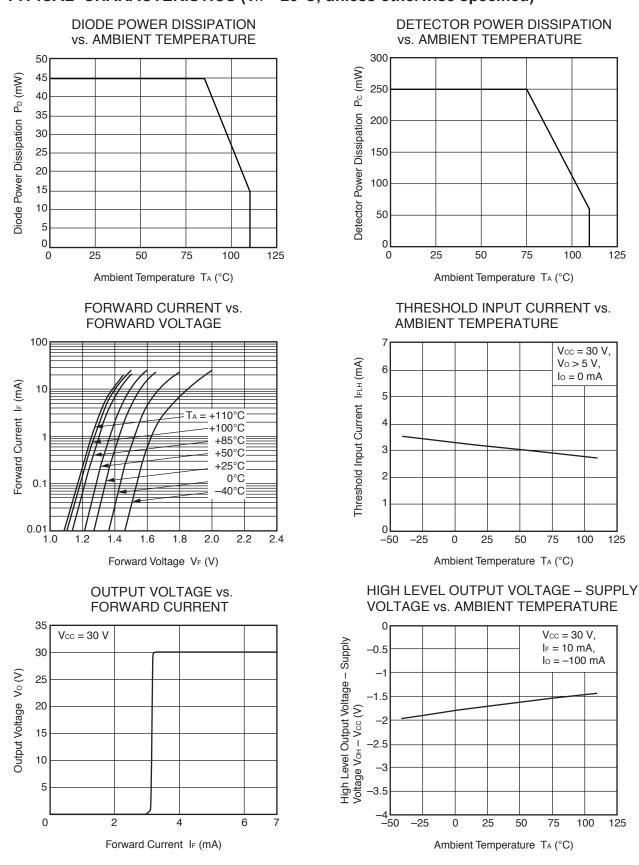


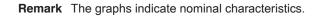
Remarks 1. Common Mode Transient Immunity at High Level Output is the maximum value of dV_{CM}/dt at which the output remains High Level (e.g. V₀ > 26 V).

2. Common Mode Transient Immunity at Low Level Output is the maximum value of dV_{CM}/dt at which the output remains Low Level (e.g. V₀ < 1.0 V).

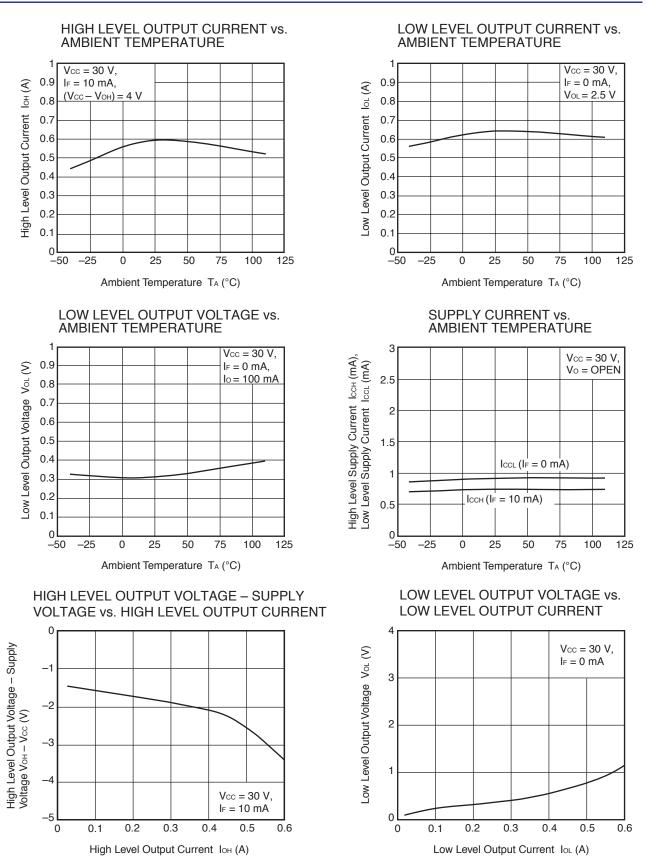


<R> TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)









Remark The graphs indicate nominal characteristics.

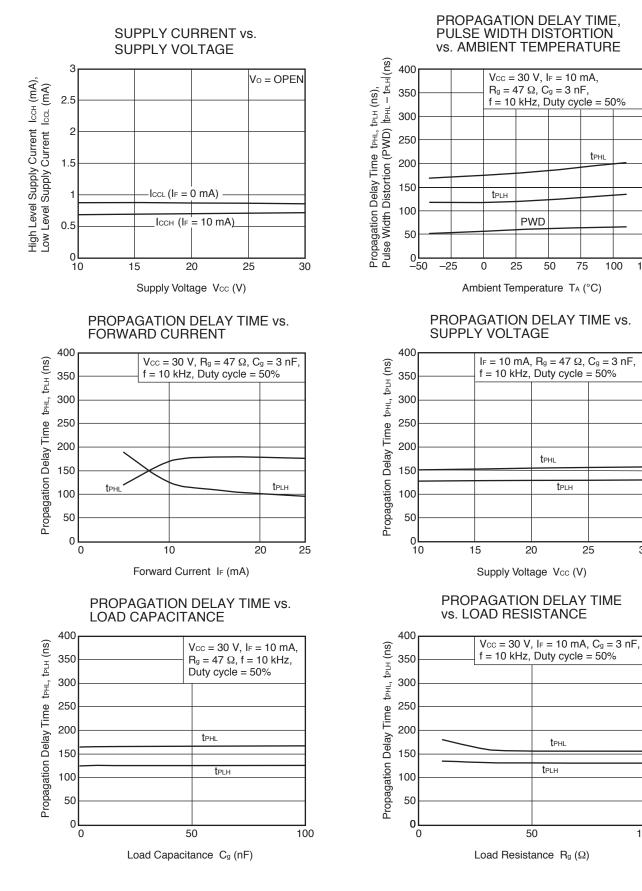
R08DS0018EJ0100 Rev.1.00 Nov 10, 2011



Low Level Output Current IoL (A)

125

30

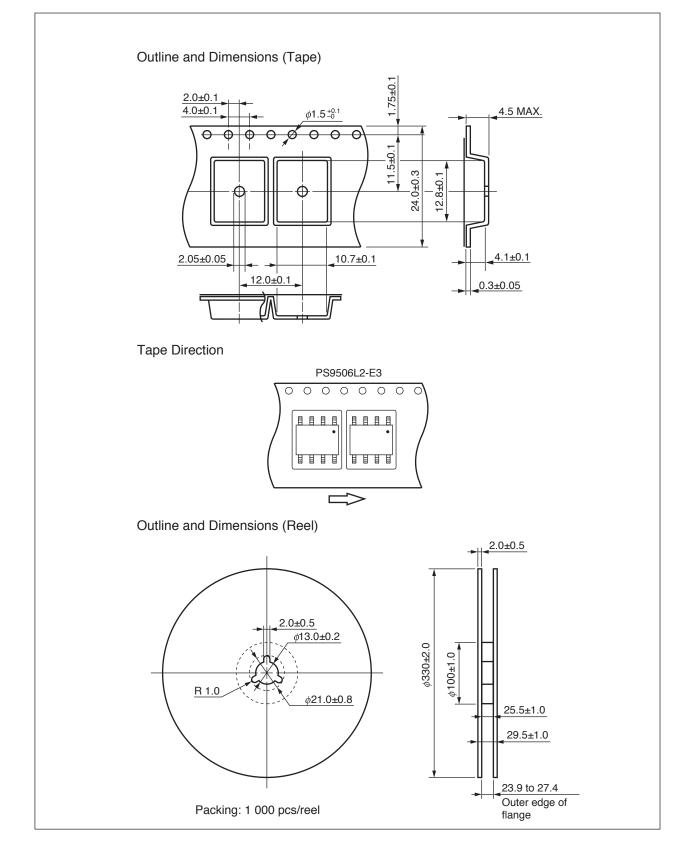


Remark The graphs indicate nominal characteristics.



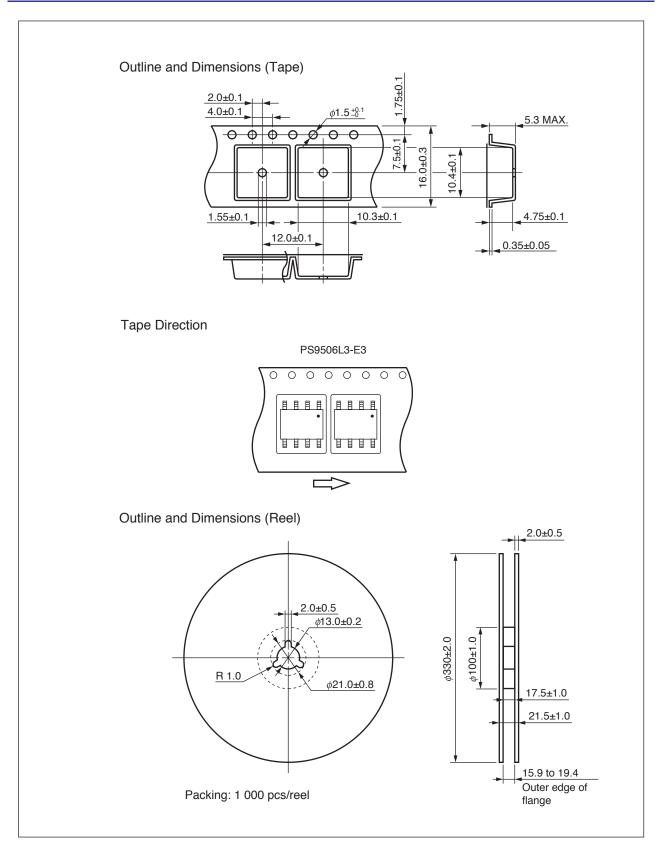
100

TAPING SPECIFICATIONS (UNIT: mm)

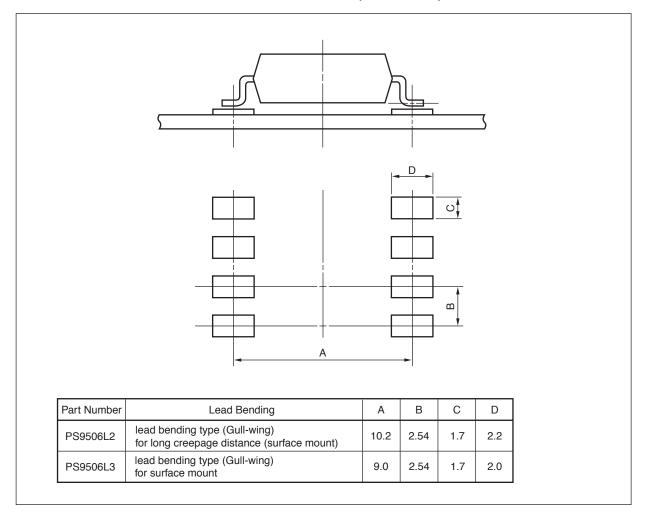








<R> RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



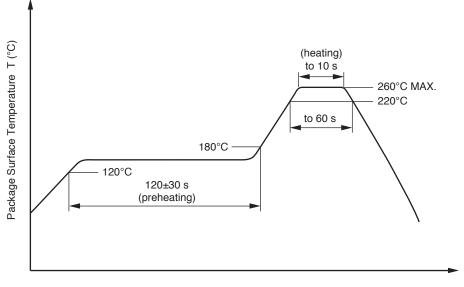


<R> NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering
 - Peak reflow temperature
 - Time of peak reflow temperature
 - Time of temperature higher than 220°C
 - Time to preheat temperature from 120 to 180°C
 - Number of reflows
 - Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350°C or below
- Time (each pins)
 Flux
 Bosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(4) Cautions

• Fluxes Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.



<R> USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. Board designing
 - (1) By-pass capacitor of more than 0.1 μ F is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
 - (2) When designing the printed wiring board, ensure that the pattern of the IGBT collectors/emitters is not too close to the input block pattern of the photocoupler.

If the pattern is too close to the input block and coupling occurs, a sudden fluctuation in the voltage on the IGBT output side might affect the photocoupler's LED input, leading to malfunction or degradation of characteristics. (If the pattern needs to be close to the input block, to prevent the LED from lighting during the off state due to the abovementioned coupling, design the input-side circuit so that the bias of the LED is reversed, within the range of the recommended operating conditions, and be sure to thoroughly evaluate operation.)

(3) Pins 1, 4 (which is an NC^{*1} pin) can either be connected directly to the GND pin on the LED side or left open. Also, Pin 7 (which is an NC^{*1} pin) can either be connected directly to the GND pin on the detector side or left open.

Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.

Note: *1. NC: Non-Connection (No Connection).

- 3. Make sure the rise/fall time of the forward current is 0.5 μ s or less.
- 4. In order to avoid malfunctions, make sure the rise/fall slope of the supply voltage is $3 \text{ V}/\mu \text{s}$ or less.
- 5. Avoid storage at a high temperature and high humidity.



<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Spec.	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/110/21	
Dielectric strength			
maximum operating isolation voltage	UIORM	1 130	V_{peak}
Test voltage (partial discharge test, procedure a for type test and random test)	U _{pr}	1 808	V_{peak}
$U_{pr} = 1.6 \times U_{IORM.}, P_d < 5 pC$			
Test voltage (partial discharge test, procedure b for all devices)	Upr	2 119	V_{peak}
$U_{pr} = 1.875 \times U_{IORM.}, P_{d} < 5 pC$			
Highest permissible overvoltage	U _{TR}	8 000	V_{peak}
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	CTI	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	T _{stg}	-55 to +125	°C
Operating temperature range	T _A	-40 to +110	°C
Isolation resistance, minimum value			
$V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$	Ris MIN.	10 ¹²	Ω
V_{IO} = 500 V dc at T _A MAX. at least 100°C	Ris MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Package temperature	Tsi	175	°C
Current (input current I _F , Psi = 0)	lsi	400	mA
Power (output or total power dissipation)	Psi	700	mW
Isolation resistance			
V_{IO} = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω





Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	 Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.



Revision History

PS9506,PS9506L1,PS9506L2,PS9506L3 Data Sheet

			Description
Rev.	Date	Page	Summary
0.01	Aug 19, 2010	_	First edition issued
1.00	Nov 10, 2011	Throughout	Preliminary Data Sheet \rightarrow Data Sheet
		Throughout	Safety standards approved
		p.4	Modification of MARKING EXAMPLE
		p.5	Addition of ORDERING INFORMATION
		p.7	Modification of ELECTRICAL CHARACTERISTICS
		pp.9, 10	Addition of TEST CIRCUIT
		pp.11 to 13	Addition of TYPICAL CHARACTERISTICS
		p.16	Modification of RECOMMENDED MOUNT PAD DIMENSIONS
		p.17	Modification of NOTES ON HANDLING
		p.18	Modification of USAGE CAUTIONS
		p.19	Addition of SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

All trademarks and registered trademarks are the property of their respective owners.

NOTICE

- Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and 1. application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. California Eastern Laboratories and Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
- 2 California Eastern Laboratories has used reasonable care in preparing the information included in this document, but California Eastern Laboratories does not warrant that such information is error free. California Eastern Laboratories and Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
- California Eastern Laboratories and Renesas Electronics do not assume any liability for infringement of patents, copyrights, or other intellectual property 3. rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of California Eastern Laboratories or Renesas Electronics or others
- You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part. California Eastern 4. Laboratories and Renesas Electronics assume no responsibility for any losses incurred by you or third parties arising from such alteration, modification, copy or otherwise misappropriation of Renesas Electronics product.
- 5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below. "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots etc. "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; and safety equipment etc. Renesas Electronics products are neither intended nor authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems, surgical implantations etc.), or may cause serious property damages (nuclear reactor control systems, military equipment etc.). You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application for which it is not intended. California Eastern Laboratories and Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for which the product is not intended by California Eastern Laboratories or Renesas Electronics.
- You should use the Renesas Electronics products described in this document within the range specified by California Eastern Laboratories, especially with 6 respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. California Eastern Laboratories shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
- 7. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or systems manufactured by you.
- Please contact a California Eastern Laboratories sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. California Eastern Laboratories and Renesas Electronics assume no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 9. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You should not use Renesas Electronics products or technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. When exporting the Renesas Electronics products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations.
- It is the responsibility of the buyer or distributor of California Eastern Laboratories, who distributes, disposes of, or otherwise places the Renesas Electronics 10. product with a third party, to notify such third party in advance of the contents and conditions set forth in this document, California Eastern Laboratories and Renesas Electronics assume no responsibility for any losses incurred by you or third parties as a result of unauthorized use of Renesas Electronics products.
- 11 This document may not be reproduced or duplicated in any form, in whole or in part, without prior written consent of California Eastern Laboratories. 12. Please contact a California Eastern Laboratories sales office if you have any questions regarding the information contained in this document or Renesas
- Electronics products, or if you have any other inquiries.

NOTE 1: "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries. NOTE 2: "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

NOTE 3: Products and product information are subject to change without notice.

CEL Headquarters • 4590 Patrick Henry Drive, Santa Clara, CA 95054 • Phone (408) 919-2500 • www.cel.com

For a complete list of sales offices, representatives and distributors, Please visit our website: www.cel.com/contactus

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for High Speed Optocouplers category:

Click to view products by CEL manufacturer:

Other Similar products are found below :

6N136F PS8502L2-AX ACNW261L-000E ACPL-344JT-000E ACPL-K49T-500E ACPL-K75T-000E ACPL-W21L-560E ACPL-K44T-500E TLP187(TPL,E(T TLP2601(TP1,F) 610737H 6N137A-X001 6N137A-X017T 6N139-X007T HCPL2630M HCPL2731SM TLP555(F) HCPL2630SM PS2841-4A-F3-AX PS9817A-1-F3-AX PS9821-2-F3-AX ORPC-817D ORPC-817M/C ORPC-817M/B PT17-51C/L129(BIN2) TLP521-4GBSM UMW817C 6N137S1(TA) TLP521GB TLP521GB-S PS2501 PS2501-S TLP785GB TLP785GB-S LTV-214-G TLP2766A(E TLP2766A(LF4,E LCR-0202 EL814S1(TA)-V PC817X4NSZ2B CYPC817 OR-MOC3023 TLP267J(TPL,E(T TLP109(TPL,E(O EL2514S1(TU)(CLW)-G EL816S2(C)(TU)-F EL814S(A)(TU) TLP281-4 MOC3023M ACPL-K49T-060E